

LINE CARD

3M	FAIRCHILD (ONSEMI)	MICROCHIP TECHNOLOGY	SEIKO
ADI	FOX	MICRON TECHNOLOGY	SEMTECH
ABRACON	FUJITSU	MICROSEMI	SHARP
ADVANCED MICRO DEVICES (AMD)	GLENAIR	MITSUBISHI	SIEMENS
AERO-ELECTRIC	HIROSE ELECTRIC	MOLEX	SIGMA
AGILENT	HITACHI	MOTOROLA	SILICON LABS
AIRBORN	HONEYWELL	MURATA	SKYWORKS
ALLEGRO	INFINEON	MURATA MANUFACTURING	SOURIAU
ALLEGRO MICROSYSTEMS	INFINEON (CYPRESS)	NDK	STMI
ALLEN-BRADLEY	INFINEON TECHNOLOGIES AG	NEXPERIA	STMICROELECTRONICS
AMP (TE CONNECTIVITY)	INTEL	NICHICON	SULLINS
AMPHENOL	INTEL/ALTERA	NVIDIA	SUNBANK
AMPHENOL RF	INTERNATIONAL RECTIFIER (INFINEON)	NXP	SV MICROWAVE
AMS-OSRAM	INTERSIL (RENESAS)	NXP SEMICONDUCTORS	SWITCHCRAFT
ANALOG DEVICES	INVENSENSE	OMRON	TAITEK
ATMEL DEVICES	ISMET	ONSEMI	TAIWAN SEMICONDUCTOR (TSMC)
AVX/KYOCERA	ITT CANNON	PANASONIC	TAIYO YUDEN
BOURNS	ITT INC	PANDUIT	TDK
BROADCOM	ITT VEAM	PASTERNAK	TE CONNECTIVITY
BURNDY	JAE	POSITRONIC	TEXAS INSTRUMENTS
BUSSMANN / EATON	JST	POTTER & BRUMFIELD (TE)	TI
C&K COMPONENTS	KEMET (YAGEO)	QORVO	TOSHIBA
CINCH	KEMET CORPORATION	QUALCOMM	TRIQUINT
CIRRUS LOGIC	KINGSTON	RADIALL	TRI-STAR
COAXIAL COMPONENTS (COAXICOM)	KOA SPEER	REALTEK	TYCO (TE CONNECTIVITY)
COILCRAFT	KONTRON	RECOM POWER	UNITED CHEMI-CON
CORNELL-DUBILIER (CDE)	KYOCERA AVX COMPONENTS CORPORATION	RENESAS	VISHAY
CORSAIR	LATTICE	RENESAS (NEC)	VISHAY SILICONIX
COTO TECHNOLOGY	LINEAR TECHNOLOGY (ADI)	ROHM	WINBOND
CRYSTEK	LITTELFUSE	SAMSUNG	WINCHESTER
DELTA ELECTRONICS	MACOM	SAMSUNG ELECTRO-MECHANICS	WÜRTH
DIODES	MARVELL	SAMTEC	XICOR (INTERSIL)
DIODES INCORPORATED	MAXIM INTEGRATED	SAN-TRON	XILINX
EPCOS (TDK)	MELEXIS	SANYO (ONSEMI)	YAGEO
EPSON	MICROCHIP	SEAGATE	